

# TPS5430/31EVM-173 3-A, Regulator Evaluation Module

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## 1 Introduction

This user's guide contains background information for the TPS5430 and TPS5431 as well as support documentation for the TPS5430EVM-173 evaluation module (HPA173-001) and the TPS5431EVM-173 evaluation module (HPA173-002). Also included are the performance specifications, the schematic, and the bill of materials for the TPS5430EVM-173 and the TPS5431EVM-173.

### 1.1 Background

The TPS5430 and TPS5431 dc/dc converters are designed to provide up to a 3-A output from an input voltage source of 5.5 V to 36 V (TPS5430) or 5.5 V to 23 V (TPS5431EVM-173). Rated input voltage and output current range for the evaluation module is given in [Table 1](#). This evaluation module is designed to demonstrate the small printed-circuit-board areas that may be achieved when designing with the TPS5430 and TPS5431 regulators. The switching frequency is internally set at a nominal 500 kHz. The high-side MOSFET is incorporated inside the TPS5430/31 package along with the gate drive circuitry. The low drain-to-source on resistance of the MOSFET allows the TPS5430/31 to achieve high efficiencies and helps keep the junction temperature low at high output currents. The compensation components are provided internal to the integrated circuit (IC), whereas an external divider allows for an adjustable output voltage. Additionally, the TPS5430/31 provides an enable input. The absolute maximum input voltage is 38 V for the TPS5430EVM-173 and 25 V for the TPS5431EVM-173.

**Table 1. Input Voltage and Output Current Summary**

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE
TPS5430EVM-173	V <sub>IN</sub> = 10 V to 35 V	0 A to 3 A
TPS5431EVM-173	V <sub>IN</sub> = 9 V to 21 V	0 A to 3 A

### 1.2 Performance Specification Summary

A summary of the TPS5430EVM-173 performance specifications is provided in [Table 2](#). Specifications are given for an input voltage of V<sub>IN</sub> = 15 V and an output voltage of 5 V, unless otherwise specified. The TPS5430EVM-173 is designed and tested for V<sub>IN</sub> = 10 V to 35 V. The ambient temperature is 25°C for all measurements, unless otherwise noted.

**Table 2. TPS5430EVM-173 and TPS5431EVM-173 Performance Specification Summary**

SPECIFICATION		TEST CONDITIONS		MIN	TYP	MAX	UNIT
VIN voltage range	TPS5430EVM-173			10	15	35	V
	TPS5431EVM-173			9	15	21	
Output voltage set point				5.0			V
Output current range		V <sub>IN</sub> = 3.3 V		0	3		A
Line regulation	TPS5430EVM-173	I <sub>O</sub> = 0 A – 3 A, V <sub>IN</sub> = 10 V – 35 V		±0.07%			
	TPS5431EVM-173	I <sub>O</sub> = 0 A – 3 A, V <sub>IN</sub> = 9 V – 21 V		±0.04%			
Load regulation	TPS5430EVM-173	V <sub>IN</sub> = 15 V, I <sub>O</sub> = 0 A to 3 A		±0.03%			
	TPS5431EVM-173			±0.05%			
Load transient response	TPS5430EVM-173	I <sub>O</sub> = 0.75 A to 2.25 A	Voltage change	–50		mV	
			Recovery time	150		µs	
	TPS5431EVM-173		Voltage change	–40		mV	
			Recovery time	150		µs	
	TPS5430EVM-173	I <sub>O</sub> = 2.25 A to 0.75 A	Voltage change	50		mV	
			Recovery time	150		µs	
			TPS5431EVM-173	Voltage change	40		mV
				Recovery time	150		µs
Loop bandwidth	TPS5430EVM-173	V <sub>IN</sub> = 25 V, I <sub>O</sub> = 1 A		25.0			kHz
	TPS5431EVM-173	V <sub>IN</sub> = 15 V, I <sub>O</sub> = 1 A		23.9			

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**Table 2. TPS5430EVM-173 and TPS5431EVM-173 Performance Specification Summary (continued)**

SPECIFICATION		TEST CONDITIONS	MIN	TYP	MAX	UNIT
Phase margin	TPS5430EVM-173	V <sub>IN</sub> = 25 V, I <sub>o</sub> = 1 A		50°		
	TPS5431EVM-173	V <sub>IN</sub> = 15 V, I <sub>o</sub> = 1 A		51°		
Input ripple voltage	TPS5430EVM-173	I <sub>o</sub> = 3 A		255	300	mVpp
	TPS5431EVM-173			295	350	
Output ripple voltage	TPS5430EVM-173	I <sub>o</sub> = 3 A		20		mVpp
	TPS5431EVM-173			20		
Output rise time				8		ms
Operating frequency				500		kHz
Max efficiency	TPS5430EVM-173	V <sub>IN</sub> = 10 V, V <sub>O</sub> = 5 V, I <sub>o</sub> = 0.75 A		93.6%		
	TPS5431EVM-173	V <sub>IN</sub> = 9 V, V <sub>O</sub> = 5 V, I <sub>o</sub> = 0.75 A		94.0%		

### 1.3 Modifications

These evaluation modules are designed to demonstrate the small size that can be attained when designing with the TPS5430 and TPS5431. A few changes can be made to this module.

#### 1.3.1 Output Voltage Set Point

To change the output voltage of the EVMs, it is necessary to change the value of resistor R2. Changing the value of R2 can change the output voltage above 1.25 V. The value of R2 for a specific output voltage can be calculated using [Equation 1](#).

$$R2 = 10 \text{ k}\Omega \times \frac{1.221 \text{ V}}{V_O - 1.221 \text{ V}} \quad (1)$$

[Table 3](#) lists the R2 values for some common output voltages. Note that V<sub>IN</sub> must be in a range so that the minimum on-time is greater than 200 ns, and the maximum duty cycle is less than 87%. The values given in [Table 3](#) are standard values, not the exact value calculated using [Equation 1](#).

**Table 3. Output Voltages Available**

Output Voltage (V)	R <sub>2</sub> Value (kΩ)
1.8	21.5
2.5	9.53
3.3	5.90
5	3.24

## 2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS5430EVM-173 and TPS5431EVM-173 evaluation modules. The section also includes test results typical for the evaluation modules and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and startup.

### 2.1 Input/Output Connections

The TPS5430EVM-173 and TPS5431EVM-173 are provided with input/output connectors and test points as shown in [Table 4](#). A power supply capable of supplying 3 A must be connected to J1 through a pair of 20 AWG wires. The load must be connected to J3 through a pair of 20 AWG wires. The maximum load current capability should be 3 A. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the V<sub>IN</sub> input voltages with TP2 providing a convenient ground reference. TP3 is used to monitor the output voltage with TP4 as the ground reference.

**Table 4. EVM Connectors and Test Points**

Reference Designator	Function
J1	VIN (see Table 1 for Vin range)
J2	OUT, 5 V at 3 A maximum
JP1	2-pin header for enable. Connect EN to ground to disable, open to enable.
TP1	VIN test point at VIN connector
TP2	GND test point at VIN
TP3	Output voltage test point at OUT connector
TP4	GND test point at OUT connector
TP5	Test point between voltage divider network and R3. Used for loop response measurements.
TP6	PH test point

## 2.2 Efficiency

The efficiency for both EVMs peak at a load current of about 0.75 A and then decrease as the load current increases towards full load. Figure 1 shows the efficiency for the TPS5430EVM-173 at an ambient temperature of 25°C.

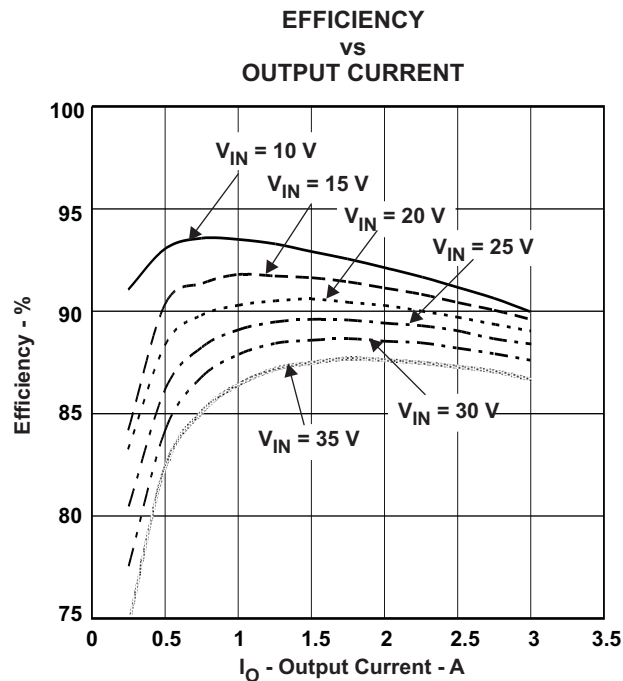

**Figure 1. TPS5430 Efficiency**

Figure 2 shows the efficiency for the TPS5431EVM-173 at an ambient temperature of 25°C.

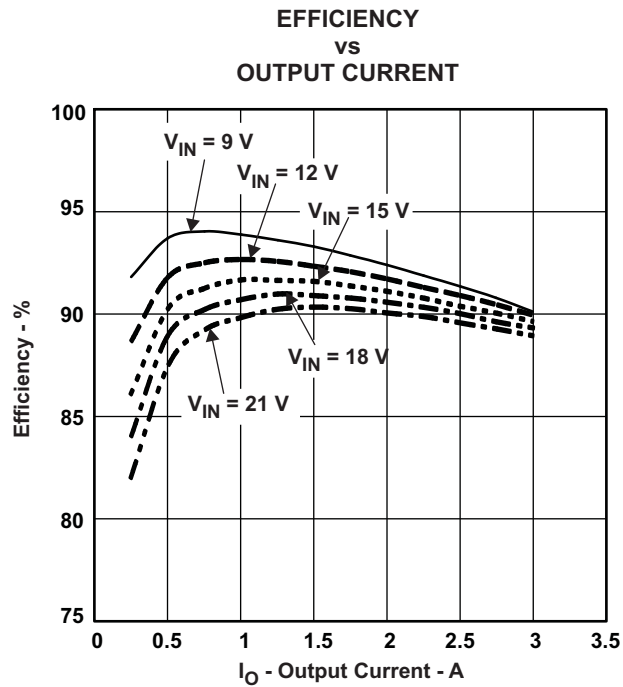


Figure 2. TPS5431 Efficiency

The efficiency is lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the MOSFETs.

### 2.3 Output Voltage Load Regulation

The load regulation for the TPS5430EVM-173 and TPS5431EVM-173 are shown in [Figure 3](#) and [Figure 4](#).

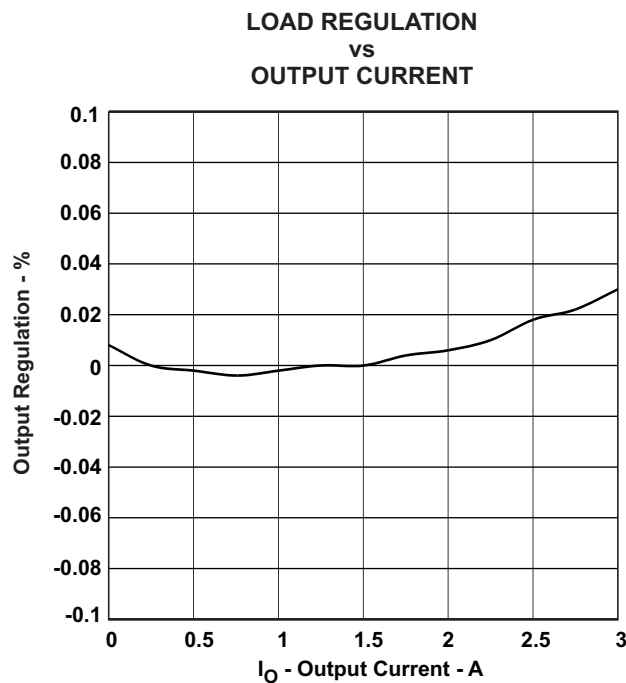


Figure 3. TPS5430 Load Regulation

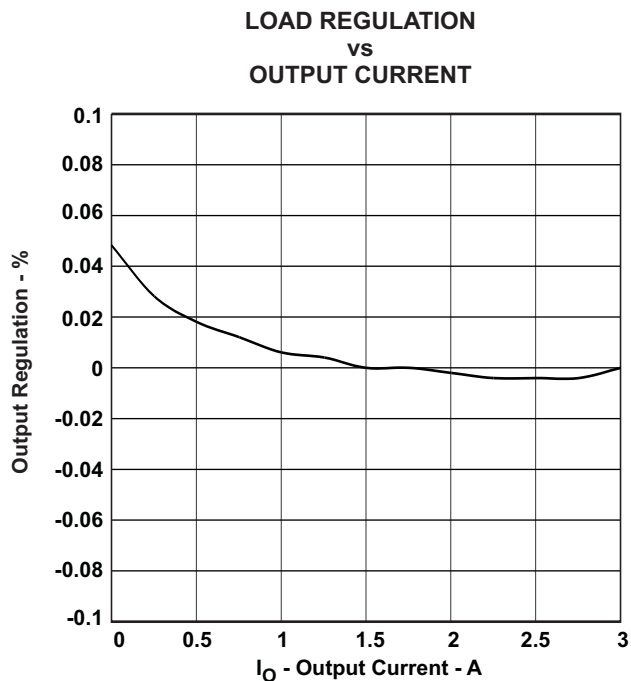


Figure 4. TPS5431 Load Regulation

Measurements are given for an ambient temperature of 25°C.

## 2.4 Output voltage Line Regulation

The load regulation for the TPS5430EVM-173 and TPS54310EVM-173 are shown in [Figure 5](#) and [Figure 6](#).

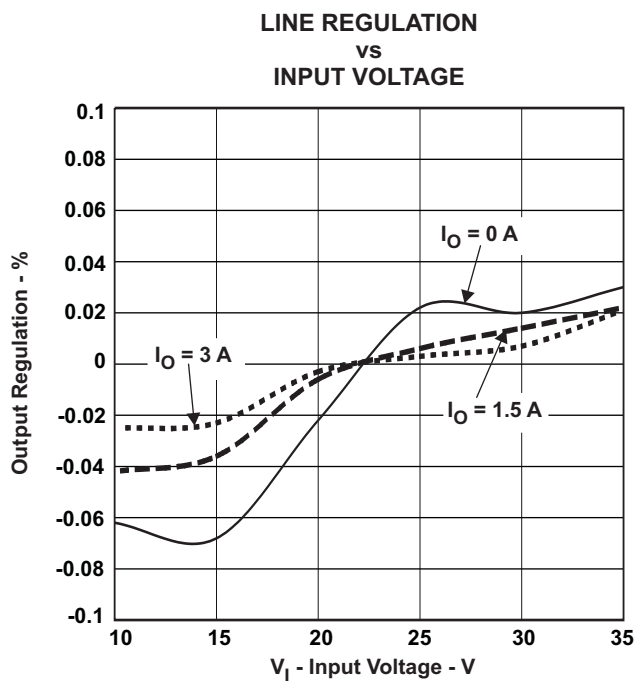


Figure 5. TPS5430 Line Regulation

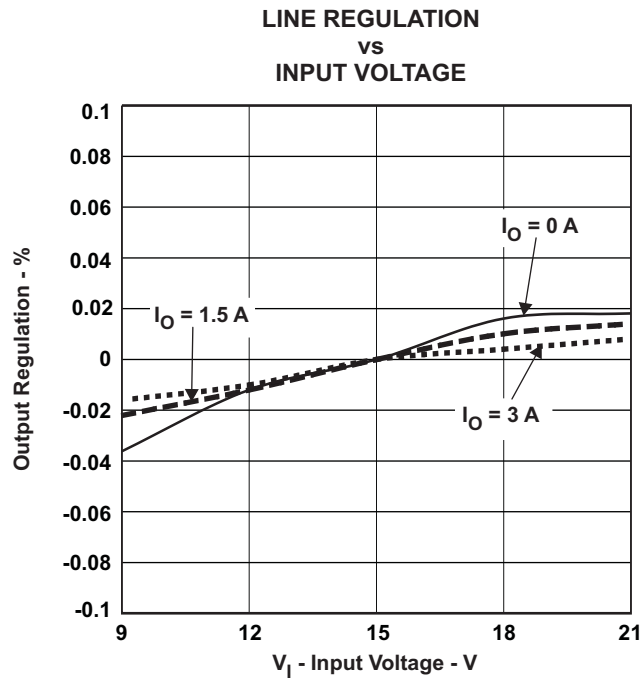


Figure 6. TPS5431 Line Regulation

## 2.5 Load Transients

The TPS5430EVM-173 and TPS5431EVM-173 response to load transients is shown in [Figure 7](#) and [Figure 8](#). The current step is from 25% to 75% of maximum rated load. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

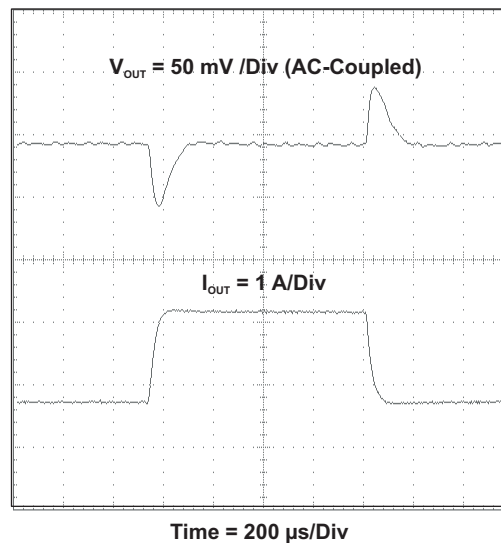


Figure 7. PS5430 Transient Response

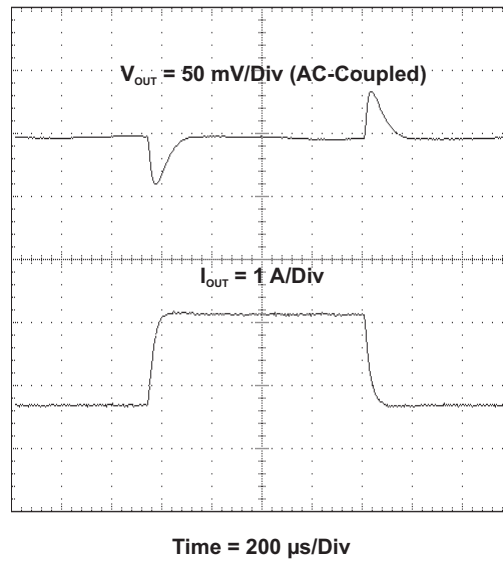


Figure 8. TPS5431 Transient Response

## 2.6 Loop Characteristics

The TPS5430EVM-173 and TPS5431EVM-173 loop-response characteristics are shown in [Figure 9](#) and [Figure 10](#). Gain and phase plots are shown for VIN voltage of 25 V for the TPS5430EVM-173 and 15 V for the TPS5431EVM-173. Load current for both measurements is 1 A.

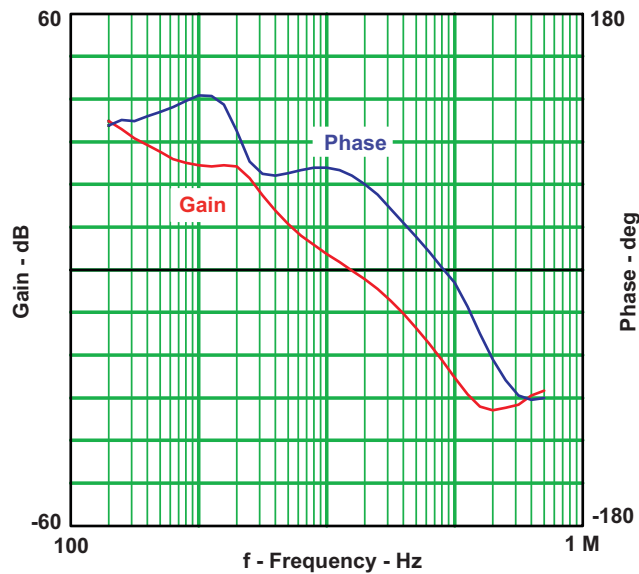


Figure 9. TPS5430 Loop Response



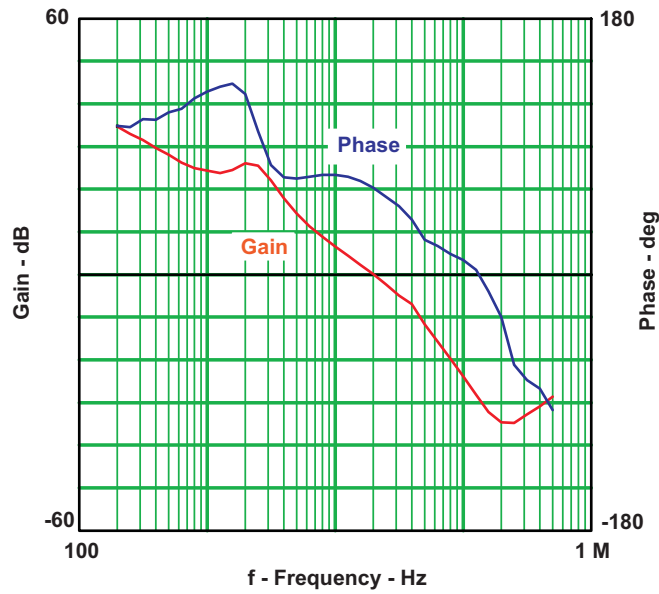


Figure 10. PS5431 Loop Response

### 2.7 Output Voltage Ripple

The TPS5430EVM-173 and TPS5431EVM-173 output voltage ripple is shown in Figure 11 and Figure 12 . The output current is the rated full load of 3 A. Voltage is measured directly across output capacitors.

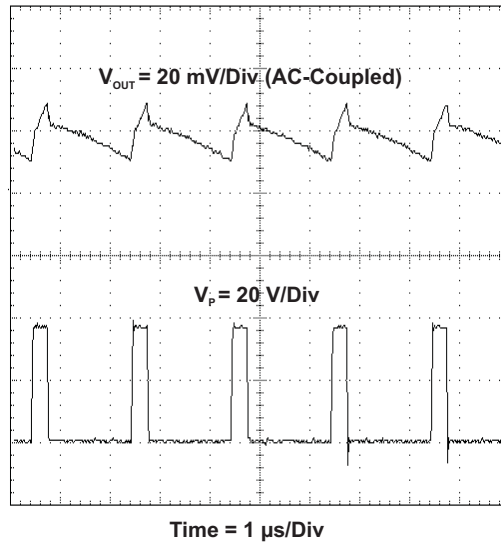


Figure 11. TPS5430 Output Ripple

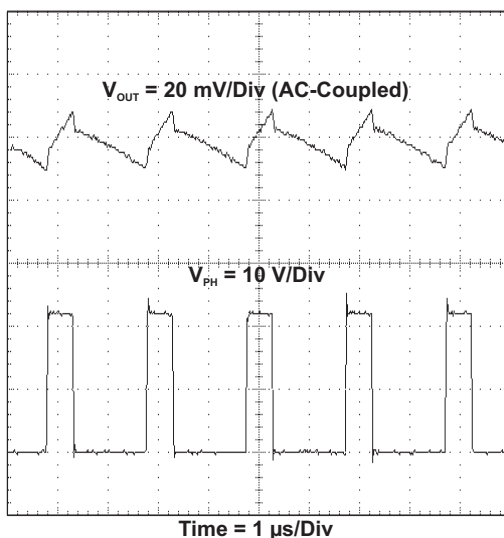


Figure 12. PS5431 Output Ripple

### 2.8 Input Voltage Ripple

The TPS5430EVM-173 and TPS5431EVM-173 input voltage ripple is shown in [Figure 13](#) and [Figure 14](#). The output current for each device is at full rated load of 3 A.

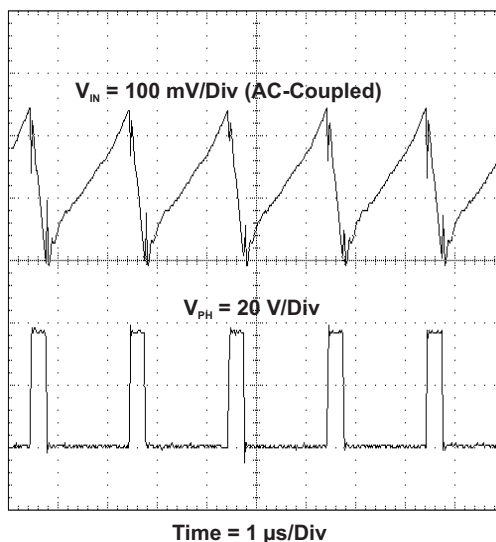


Figure 13. TPS5430 Input Ripple

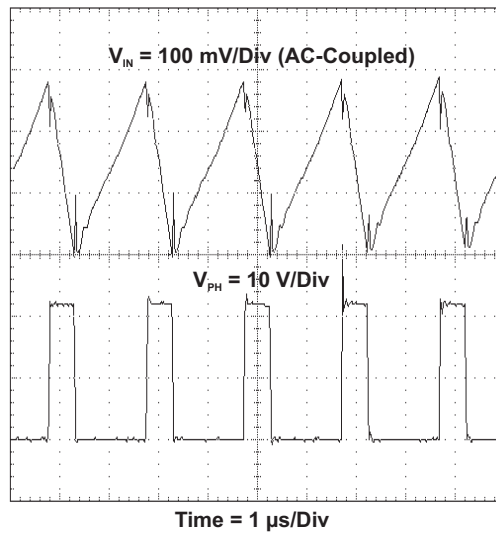


Figure 14. TPS5431 Input Ripple

## 2.9 Powering Up

The start-up waveform is shown in Figure 15. The top trace shows ENA, and the bottom trace shows  $V_{out}$ . Initially, the output is inhibited by using a jumper at JP1 to tie EN to GND. When the jumper is removed, ENA is released. When the ENA voltage reaches the enable-threshold voltage of 1.06 V, the start-up sequence begins and the internal reference voltage begins to ramp up at the internally set rate towards 1.221 V and the output voltage ramps up to the externally set value of 5 V. The start-up waveform is the same for both the TPS5430EVM-173 and the TPS5431EVM-173.

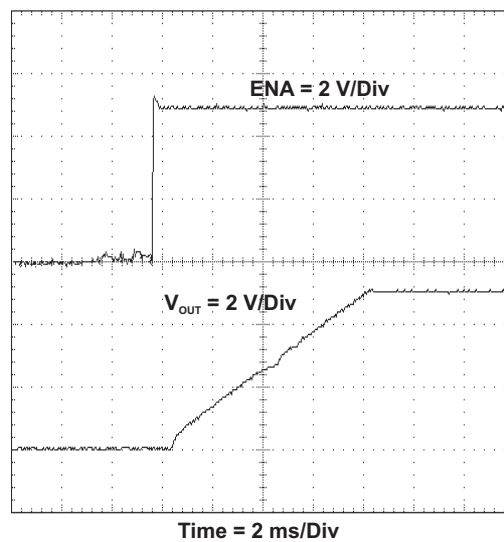


Figure 15. TPS5430 and TPS5431 Start-Up

### 3 Board Layout

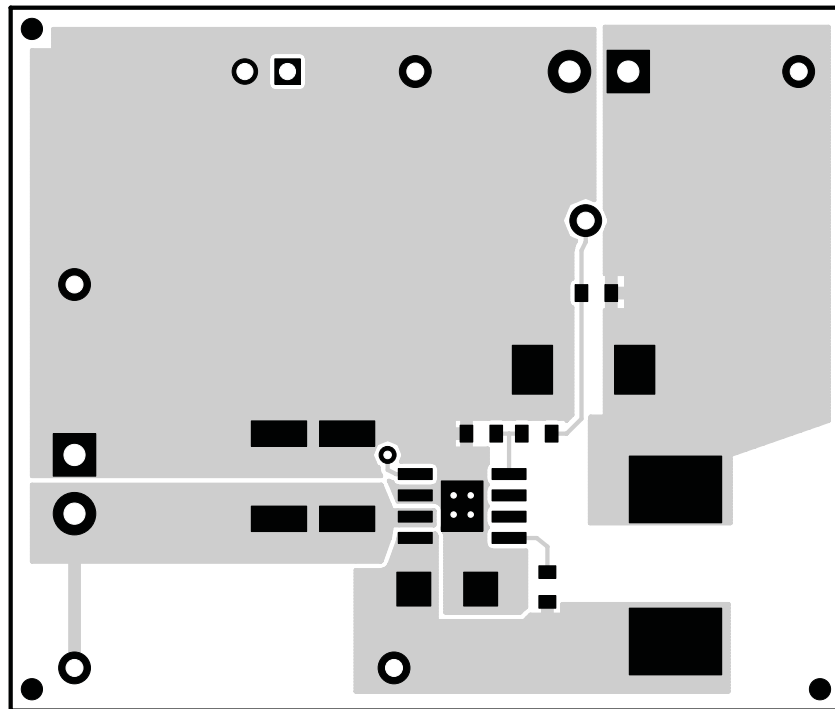
This section provides a description of the TPS5430EVM-173 and TPS5431EVM-173 board layout and layer illustrations.

#### 3.1 Layout

The board layout for the TPS5430EVM-173 and TPS5431EVM-173 is shown in [Figure 16](#) through [Figure 18](#). Both EVM circuits use the same printed-circuit board (HPA173). The topside layer of the EVM is laid out in a manner typical of a user application. The top and bottom layers are 2-oz. copper.

The top layer contains the main power traces for VIN, OUT, and VPHASE. Also on the top layer are connections for the remaining pins of the TPS5430 and a large area filled with ground. The bottom layer contains ground and signal routes for the ENA feature. The top and bottom and internal ground traces are connected with multiple vias placed around the board including four vias directly under the TPS5430 device to provide a thermal path from the PowerPAD™ land to ground.

The input decoupling capacitor (C1) and bootstrap capacitor (C2) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper Vout trace past the output capacitor C3. For the TPS5430, an additional input bypass capacitor (C4) is required.



**Figure 16. Top-Side Layout**

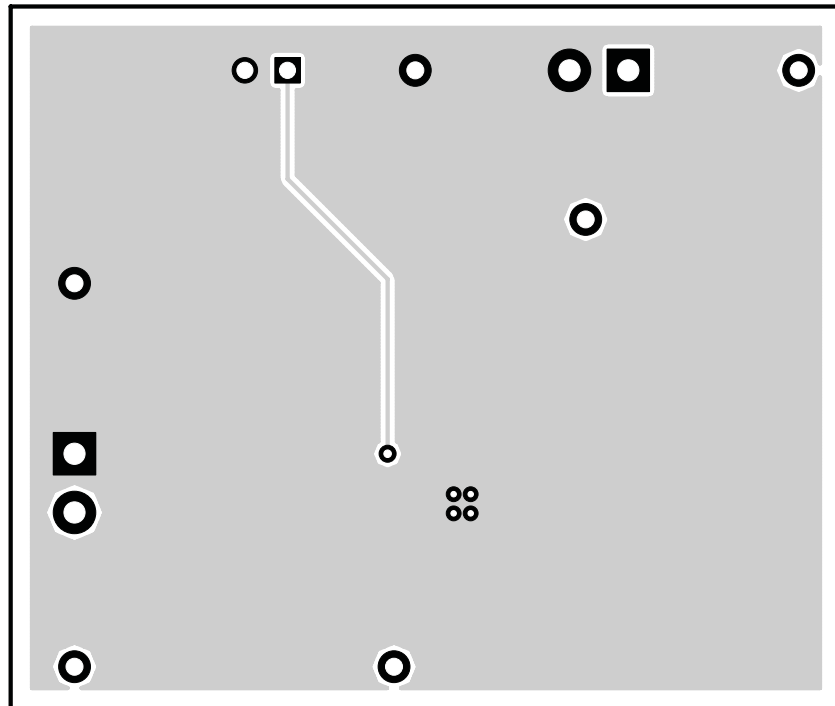


Figure 17. Bottom-Side Layout (Looking From Top Side)

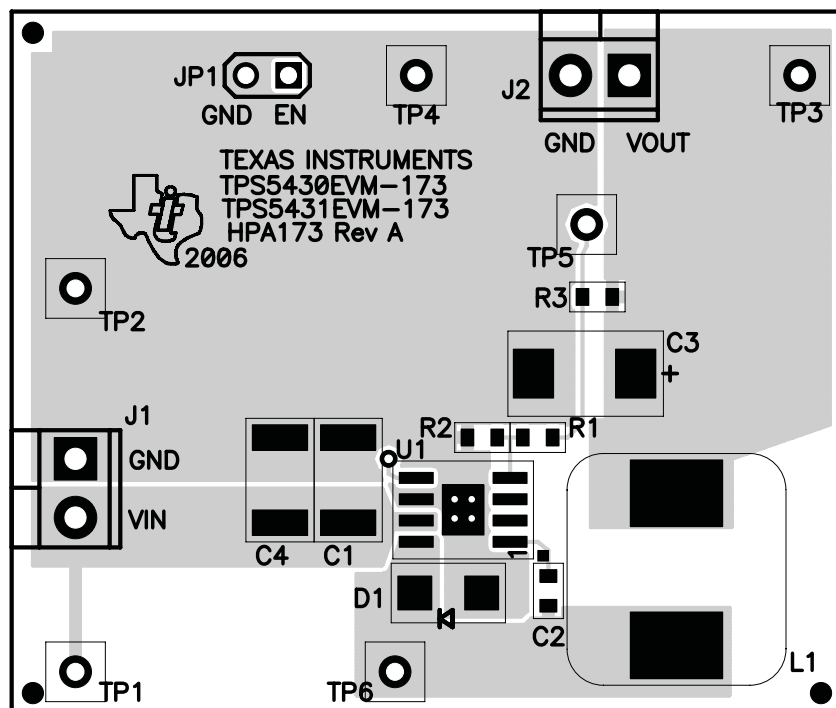


Figure 18. Top-Side Assembly

#### 4 Schematic and Bill of Materials

The TPS5430EVM-173 and TPS5431EVM-173 schematic and bill of materials are presented in this section.

### 4.1 Schematic

The schematic for the TPS5430EVM-173 and TPS5431EVM-173 is shown in Figure 19.

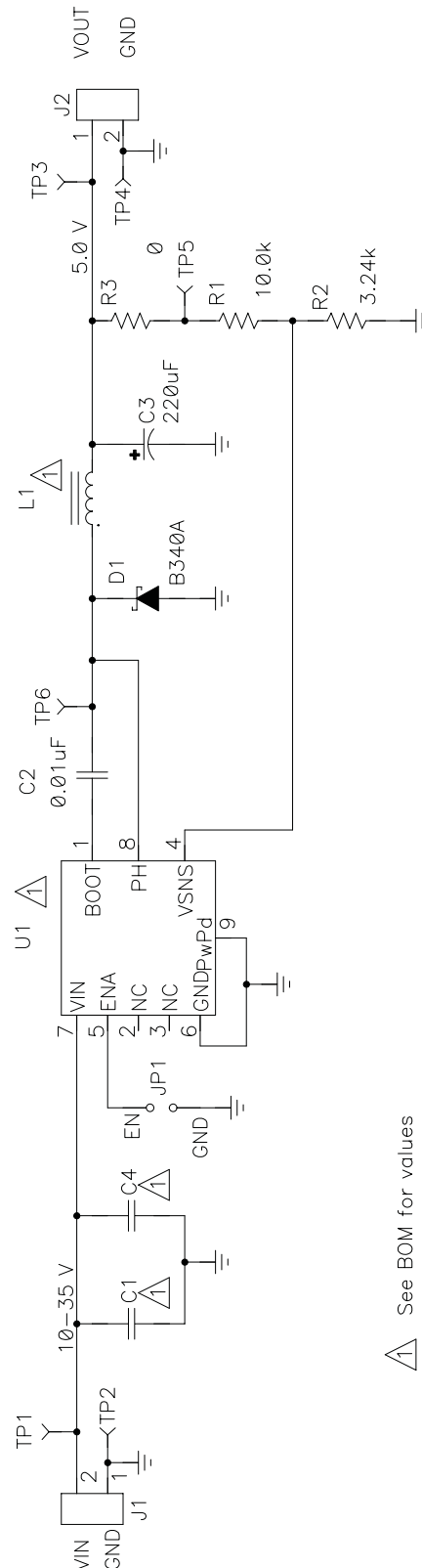


Figure 19. TPS5430EVM-173 Schematic

## 4.2 Bill of Materials

The bill of materials for the TPS5430EVM-173 and TPS5431EVM-173 is given by [Table 5](#).

**Table 5. TPS5430EVM-173 Bill of Materials**

Count		RefDes	Value	Description	Size	Part Number	MFR
-001	-002						
1	0	C1	4.7 $\mu$ F	Capacitor, Ceramic, 50V, X7R, 20%	1812	C4532X5R1H475MT	TDK
0	1		10 $\mu$ F	Capacitor, Ceramic, 25V, X7R, 20%	1812	C4532X7R1E106KT	TDK
1	1	C2	0.01 $\mu$ F	Capacitor, Ceramic, 50V, X7R, 10%	0603	C1608X7R1H103K	TDK
1	1	C3	220 $\mu$ F	Capacitor, POSCAP, 10V, 40m $\Omega$ , 20%	7343(D)	10TPB220M	Sanyo
1	0	C4	4.7 $\mu$ F	Capacitor, Ceramic, 50V, X5R, 20%	1812	C4532X5R1H475MT	TDK
1	1	D1		Diode, Schottky, 3A, 40V	SMA	B340A	Diode Inc
2	2	J1, J2		Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25	ED1514	OST
1	1	JP1		Header, 2pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	Sullins
1	0	L1	22 $\mu$ H	Inductor, Power, 3.6A, 50m $\Omega$	0.484 x 0.484	MSS1278-223MLB	Coilcraft
0	1		18 $\mu$ H	Inductor, Power, 4A, 43m $\Omega$	0.484 x 0.484	MSS1278-183MLB	Coilcraft
1	1	R1	10.0k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	1	R2	3.24k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	1	R3	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std
4	4	TP1, TP3, TP5, TP6		Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100	5000	Keystone
2	2	TP2, TP4		Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100	5001	Keystone
1	0	U1		IC, Switching Step-Down Regulator, 5.5V-36V, 3A	SO8[DDA]	TPS5430DDA	TI
0	1			IC, Switching Step-Down Regulator, 5.5V-23V, 3A	SO8[DDA]	TPS5431DDA	TI
1	1	—		PCB, 1.95 In x 1.65 In x 0.062 In		HPA173	Any
1	1	—		Shunt, 100mil, Black	0.100	929950-00	3M

## EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

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## REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

### General Statement for EVMs including a radio

*User Power/Frequency Use Obligations:* This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

### For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

#### Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.



### **FCC Interference Statement for Class B EVM devices**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

### **For EVMs annotated as IC – INDUSTRY CANADA Compliant**

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

### **Concerning EVMs including radio transmitters**

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

### **Concerning EVMs including detachable antennas**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

### **Concernant les EVMs avec appareils radio**

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### **Concernant les EVMs avec antennes détachables**

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

## **【Important Notice for Users of EVMs for RF Products in Japan】**

**This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan**

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

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## **EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS**

**For Feasibility Evaluation Only, in Laboratory/Development Environments.** Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

**Certain Instructions.** It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

**Agreement to Defend, Indemnify and Hold Harmless.** You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

**Safety-Critical or Life-Critical Applications.** If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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### Products

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Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
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Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
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